



MDWC0151ERH

Common-Drain Dual N-Channel Trench MOSFET 24V, 22A, 2.8 mΩ

General Description

The MDWC0151ERH uses advanced Magnachip's MOSFET Technology, which provides high performance in on-state resistance and excellent reliability. Excellent low $R_{\rm SS(ON)}$, low gate charge operation and operation for Battery Application.

Features

- $V_{SS} = 24V$
- Source-Source ON Resistance;

 $R_{SS(ON) \text{ max.}} 2.8 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$

 $R_{SS(ON) \text{ max.}} 3.1 \text{m}\Omega$ @ $V_{GS} = 3.8 \text{V}$

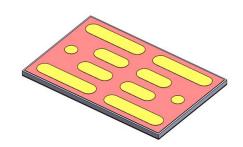
 $R_{SS(ON) \text{ max.}} 3.6 \text{m}\Omega \bigcirc V_{GS} = 3.1 \text{V}$

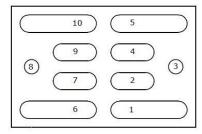
 $R_{SS(ON) \text{ max.}} 4.6 \text{m}\Omega$ @ $V_{GS} = 2.5 \text{V}$

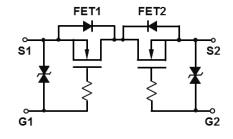
Applications

- Portable Battery Protection

Bottom View







3.2mm*2.1mm WLCSP

1, 2, 4, 5. Source1 (FET1) 3. Gate1 (FET1) 6, 7, 9, 10. Source2 (FET2) 8. Gate2 (FET2)

Absolute Maximum Ratings (T_A = 25°C unless otherwise noted)

Characteristics		Symbol	Rating	Units
Source-Source Voltage		V _{SSS}	24	V
Gate-Source Voltage		V _{GSS}	±12	V
Carrier Comment	DC*1	Is	22	Α
Source Current	Pulse	I _{SP}	88	Α
Total Power Dissipation	DC*1	P _D	2.2	W
Channel Temperature		T _{ch}	150	°C
Junction and Storage Temperature Range		T _J , T _{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance	$R_{\theta JA}$	57	°C/W

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Ordering Information

Part Number	Temp. Range	Package Packing		RoHS Status	
MDWC0151ERH	-55~150°C	WLCSP	Tape and Reel	Halogen Free	

Electrical Characteristics (T_A =25°C unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Тур	Max	Units
Static Characteristics						
Source-Source Breakdown Voltage	BV _{SSS}	I _S = 4.0mA, V _{GS} = 0V	24	-	-	V
Gate Threshold Voltage	V _{GS(th)}	$V_{SS} = V_{GS}, I_S = 250 \mu A$	0.4	0.8	1.2	
Cut-Off Current	I _{SSS}	$V_{SS} = 20V, V_{GS} = 0V$	-	-	1.0	μΑ
Gate Leakage Current	I _{GSS}	$V_{GS} = \pm 12V, V_{SS} = 0V$	-	-	10	μΑ
		V _{GS} = 4.5V, I _S = 5.0A	-	2.1	2.8	mΩ
Occurs Occurs Basistana	R _{SS(ON)}	V _{GS} = 3.8V, I _S = 5.0A	-	2.3	3.1	
Source-Source Resistance		V _{GS} = 3.1V, I _S = 5.0A	-	2.6	3.6	
		V _{GS} = 2.5V, I _S = 5.0A	-	3.2	4.6	
Dynamic Characteristics				•		•
Total Gate Charge	Q_g	V _{SS} = 15V, I _S = 5.0A, V _{GS} = 4.5V	-	74	-	nC
Gate-Source Charge	Q_{gs}		-	12	-	
Gate-Drain Charge	Q_{gd}		-	37	-	
Input Capacitance	C _{iss}		-	5,343	-	pF
Reverse Transfer Capacitance	C _{rss}	$V_{SS} = 10V, V_{GS} = 0V, f = 50kHz$	-	1,603	-	
Output Capacitance	Coss		-	1,754	-	
Turn-On Delay Time	t _{d(on)}	$V_{GS} = 4.5V, V_{SS} = 11.5V,$ $I_{S} = 5.0A, R_{GEN} = 3\Omega$	-	0.4	-	
Rise Time	t _r		-	2.8	-	- μS
Turn-Off Delay Time	$t_{d(off)}$		-	5.8	-	
Fall Time	t _f		-	20.7	-	
Drain-Source Body Diode Characteristic	S					
Source-Source Diode Forward Voltage	VF _(S-S)	I _F = 3.0A, V _{GS} = 0V	-	0.6	1.0	V

Note *1. Mounted on PCB board (30.0mm x 20.0mm)

Characteristic Graph

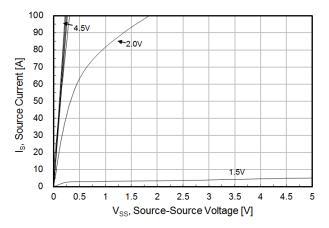


Fig.1 On-Region Characteristics

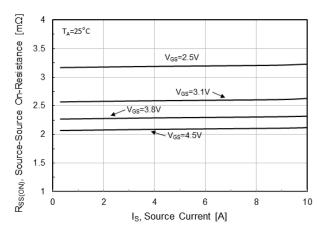


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

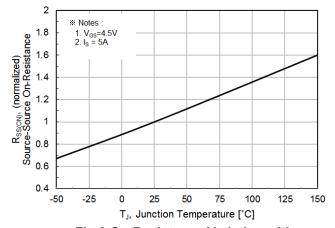


Fig.3 On-Resistance Variation with Temperature

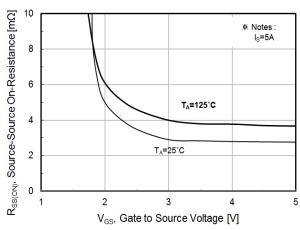


Fig.4 On-Resistance Variation with Gate to Source Voltage

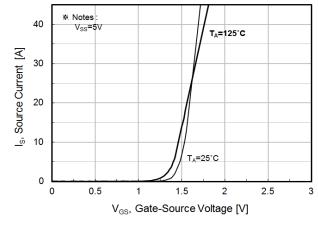


Fig.5 Transfer Characteristics

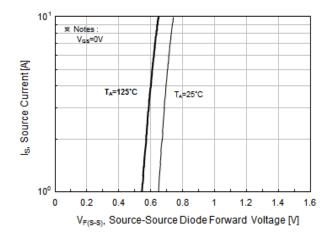


Fig.6 Forward Source to Source Characteristics

Characteristic Graph

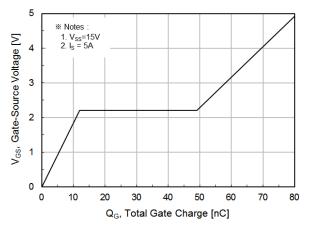


Fig.7 Gate Charge Characteristics

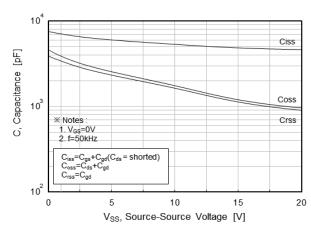


Fig.8 Capacitance Characteristics

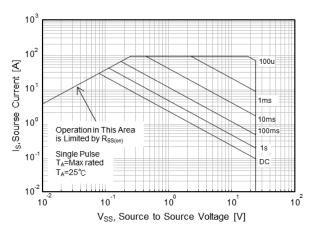


Fig.9 Maximum Safe Operating Area

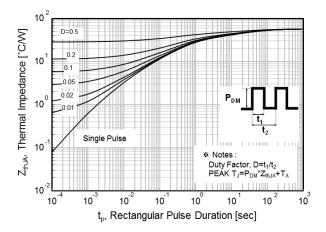
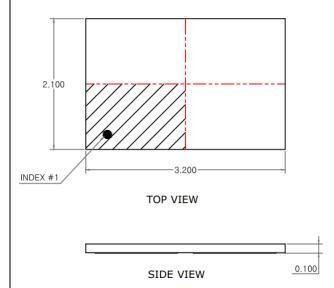
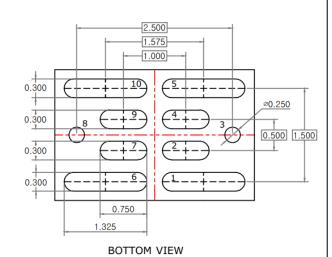


Fig.10 Transient Thermal Response Curve

PACKAGE OUTLINE





Note:

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) GENERAL TOLERANCE : $\pm~0.03~\text{mm}$
- 3) PACKAGE BODY SIZES EXCLUDE FLASH & BURRS

MDWC0151ERH- Common-Drain Dual N-Channel Trench MOSFET 24V Datasheet